

SUSS MICROTEC SE CAPITAL MARKETS DAY ONLINE CONFERENCE

September 24, 2020

AGENDA



TIME	PRESENTATIONS PRESENTER	
10:00 - 10:05	Welcome	Dr. Franz Richter, CEO
10:05 – 10:45	Markets and Business outlook	Dr. Franz Richter, CEO, Oliver Albrecht, CFO
10:45 – 11:05	Productivity Improvement	Erik Apple, COO
11:05 – 11:30	Insights Photomask Equipment	Yuta Nagai, Business Unit Manager Photomask
11:30 – 11:55	Insights MicroOptics	Dr. Reinhard Voelkel, CEO, SUSS MicroOptics SA
11:55 – 12:20	Insights Bonder	Stefan Lutter, Business Unit Manager Bonder
12:20 - 12:50	Break	
12:50 - 13:15	Insights Lithography – Exposure	Dr. Markus Arendt, Business Unit Manager Lithography
13:15 – 13:40	Insights Lithography – Coater	Dr. Ing. Thomas Grund, Business Unit Manager Coater
13:40 - 14:00	Closing Remarks	Dr. Franz Richter, CEO

SÜSS MicroTec SE Capital Markets Day 2020



CAPITAL MARKETS DAY 2020 MARKET AND BUSINESS OUTLOOK

September 24, 2020

Dr. Franz Richter, CEO Oliver Albrecht, CFO



This presentation contains forward-looking statements relating to the business, financial performance and earnings of SUSS MicroTec SE and its subsidiaries and associates. Forward-looking statements are based on current plans, estimates, projections and expectations and are therefore subject to risks and uncertainties, most of which are difficult to estimate and which in general are beyond the control of SUSS MicroTec SE. Consequently, actual developments as well as actual earnings and performance may differ materially from those which explicitly or implicitly assumed in the forward-looking statements. SUSS MicroTec SE does not intend or accept any obligation to publish updates of these forward-looking statements.







- I. SUSS Positioning in the Market
- II. Strategy SUSS 2025
- III. Remarks on Q1 and Q2 / 2020

SUSS Markets

- + SUSS MicroTec SE is serving attractive market segments in the semiconductor industry
- + SUSS provides equipment, process & application support and after sales service
- + Semiconductor Industry is very innovative, fast changing and very demanding
- + Cyclic nature of the business is a challenge to all market participants

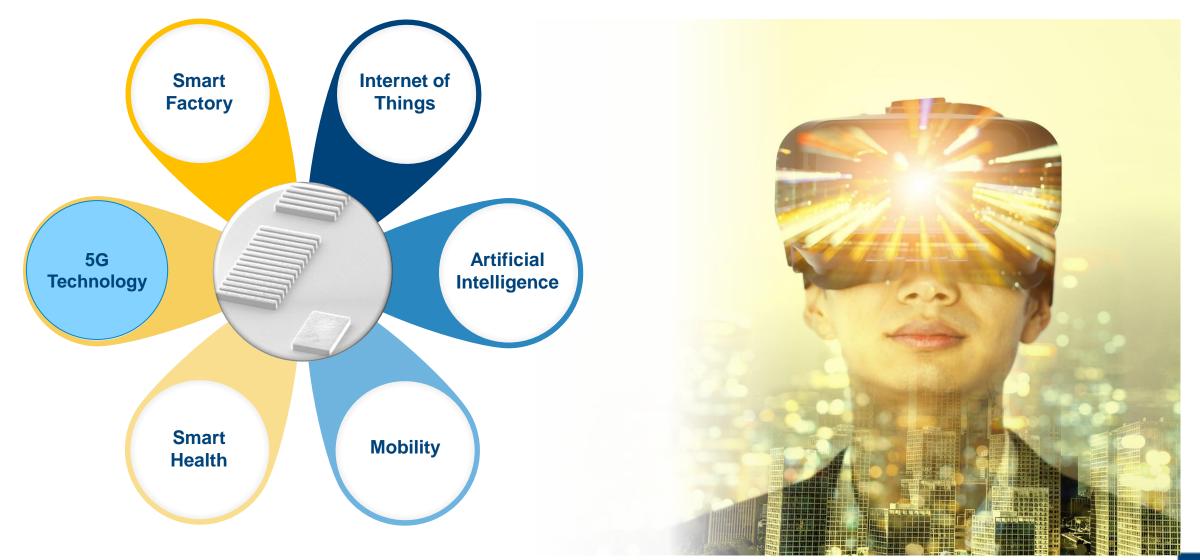
Key to success are to follow certain principles:

- + Focus on attractive growth segments
- + Analyze market environment understand specific market needs
- + Develop innovative solutions as "unique selling proposition" (USP)
- + Apply operational excellence to reach lowest "Cost of Ownership" (CoO)

Let's have a look to our market environment

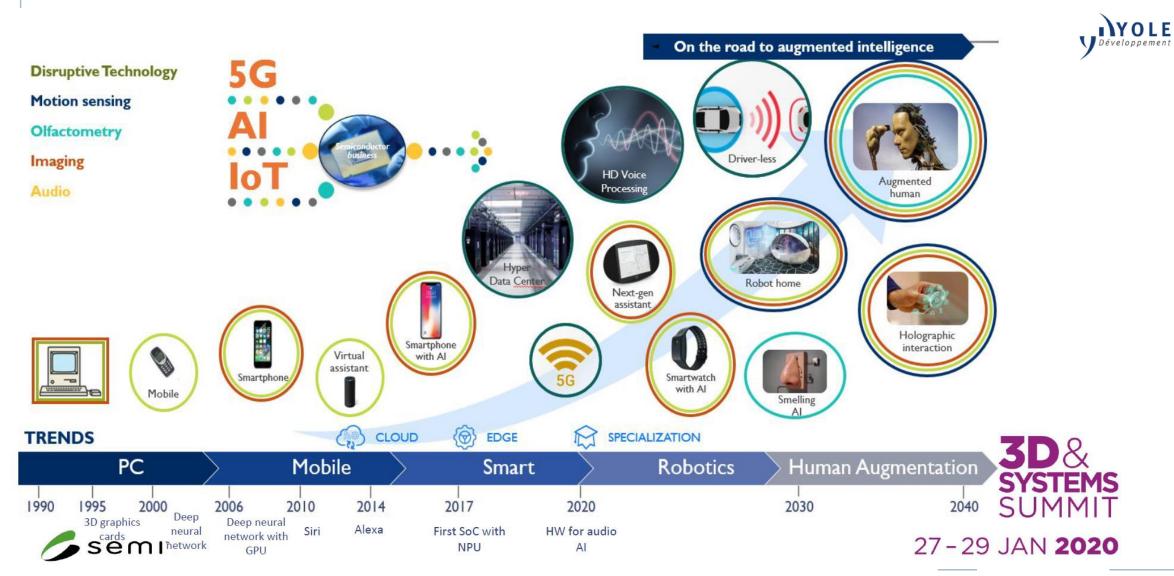
MEGATRENDS ARE DRIVING FUTURE TECHNOLOGY





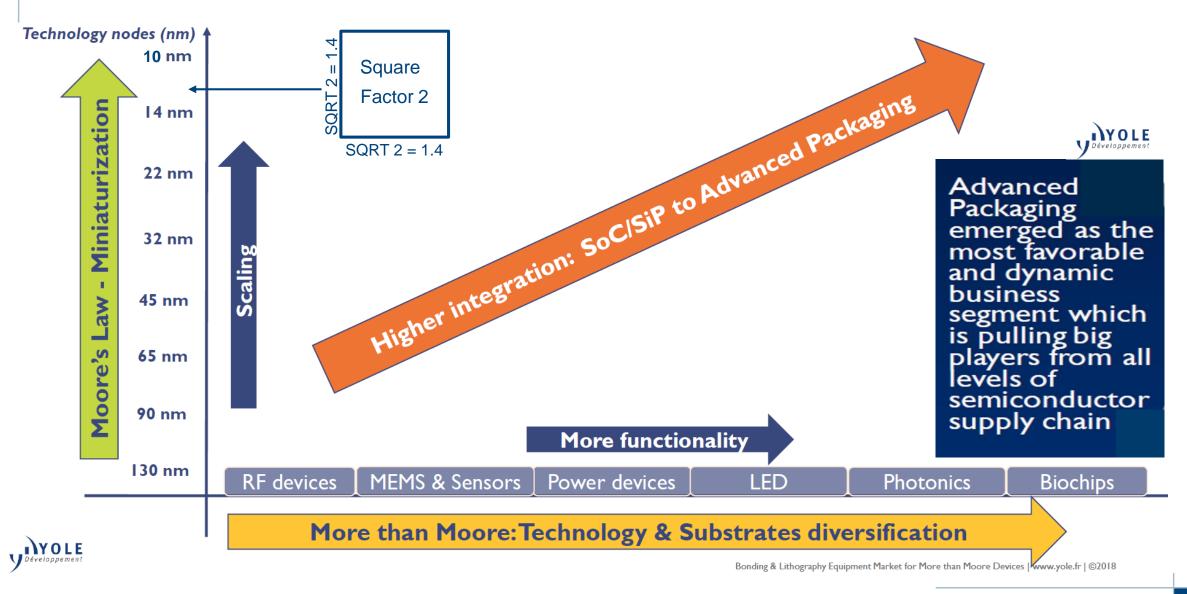
ROADMAP OF ELECTRONIC MEGA TRENDS



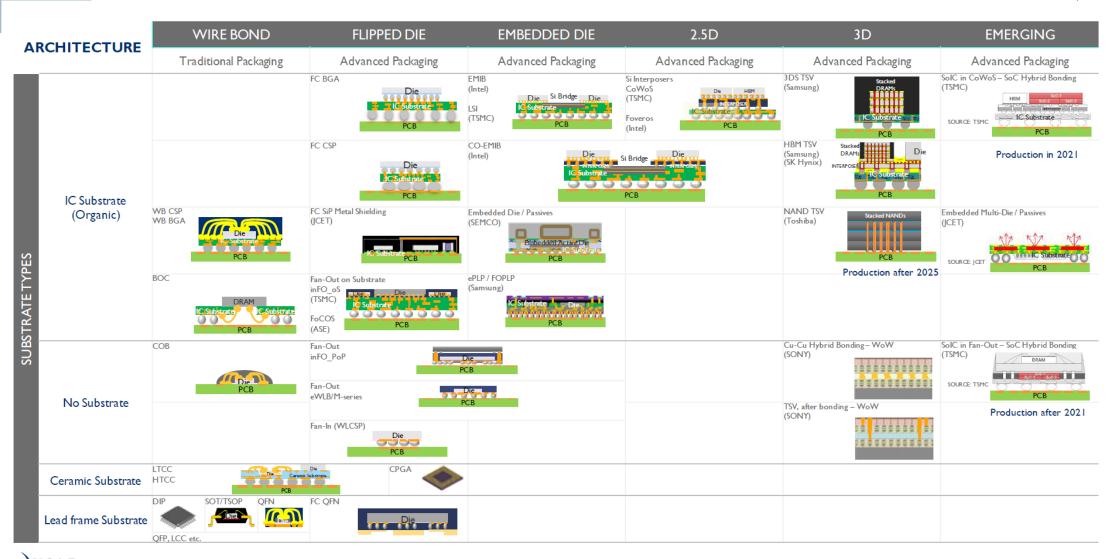


FROM "MOORE'S LAW" (SCALING) TO "MORE THAN MOORE" (FUNCTIONAL INTEGRATION)

SÜSS, MicroTec



PACKAGING TECHNOLOGIES OVERVIEW MtM-APPLICATION



Status of Advanced Packaging Industry 2020 | Report | www.yole.fr | ©2020

10

"More-than-Moore" Market Segment:

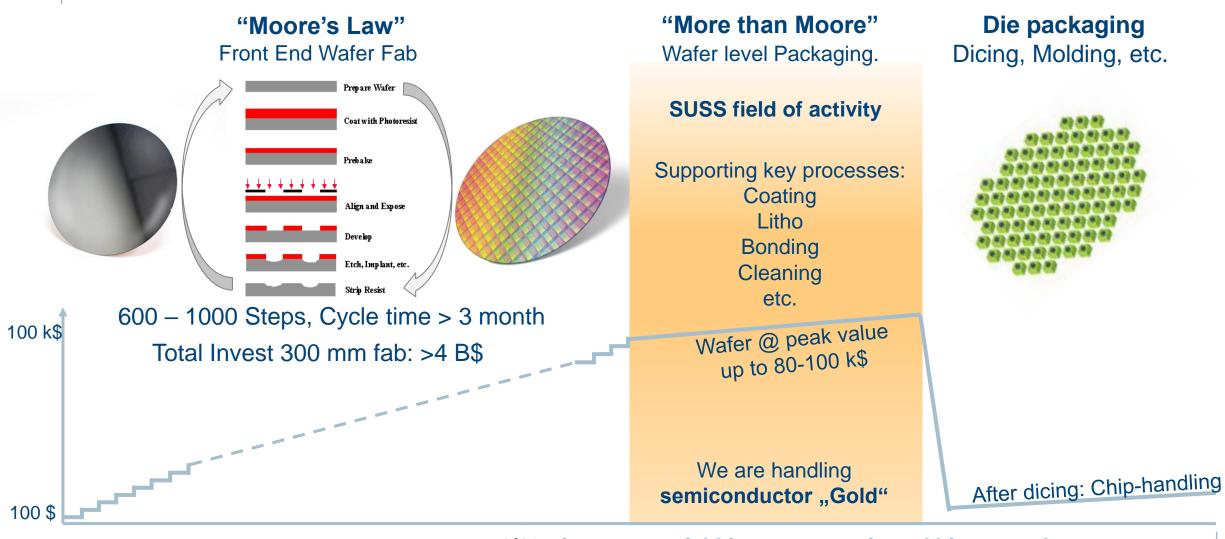
- + Very diversified \rightarrow much lower volume per product design compared to FeoL
- + Many customer have very specific process needs \rightarrow higher degree of customization
- + Complex wafer architectures: Topography, warped wafers, complex material combinations, etc.
- + High valued wafer to be handled! Most important: No wafer losses, Minimize yield loss
- + Optimized process steps per application, tailored equipment per application needed

Consequences for SUSS:

- + We need to have the best understanding of the application
- + Reliability is key! Safety features and methods need to be applied and incorporated
- + Metrology will become more important than in the past
- + Traceability and Process Control using AI-SW-Packages

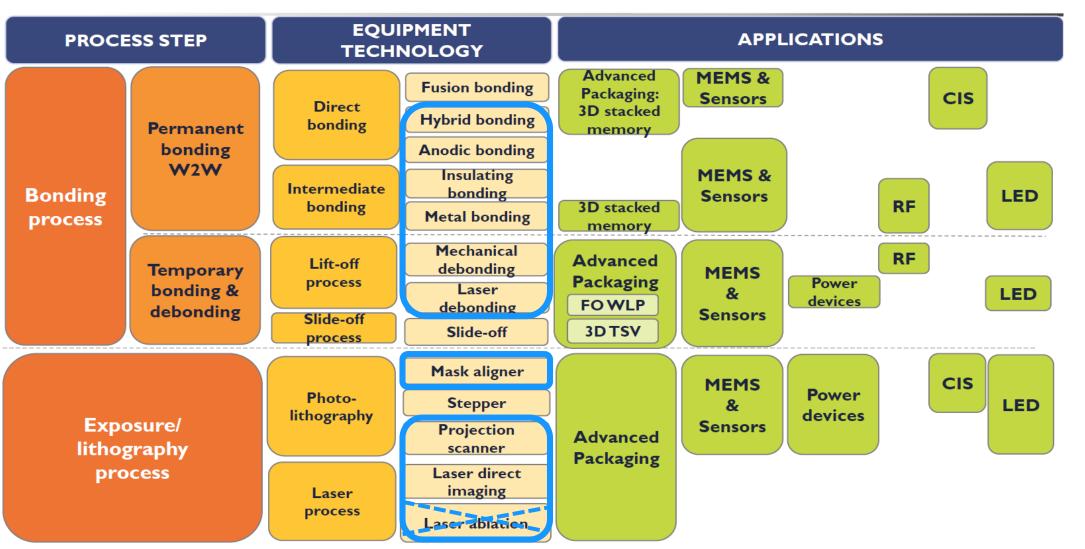
SEMICONDUCTOR PROCESS FLOW





1/10 of a percent yield improvement is real big money!

BONDING AND LITHOGRAPHY PROCESSES IN THE "MtM" FIELD



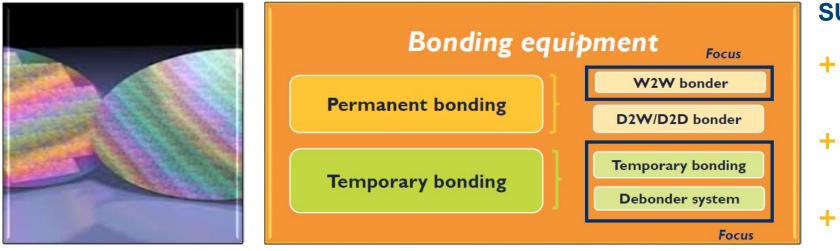


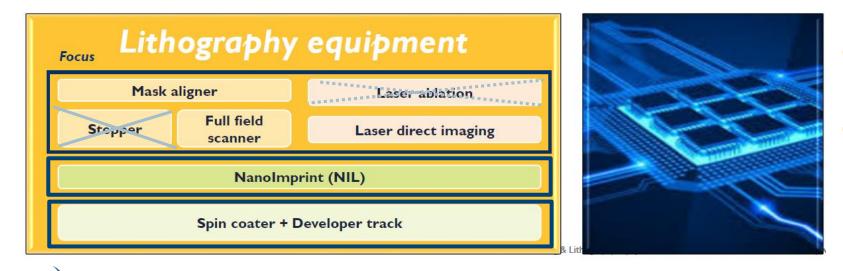
Bonding & Lithography Equipment Market for More than Moore Devices | www.yole.fr | ©2018

13

SUSS' EQUIPMENT FOCUS FOR "MtM" APPLICATION







I)YOLE Développemen

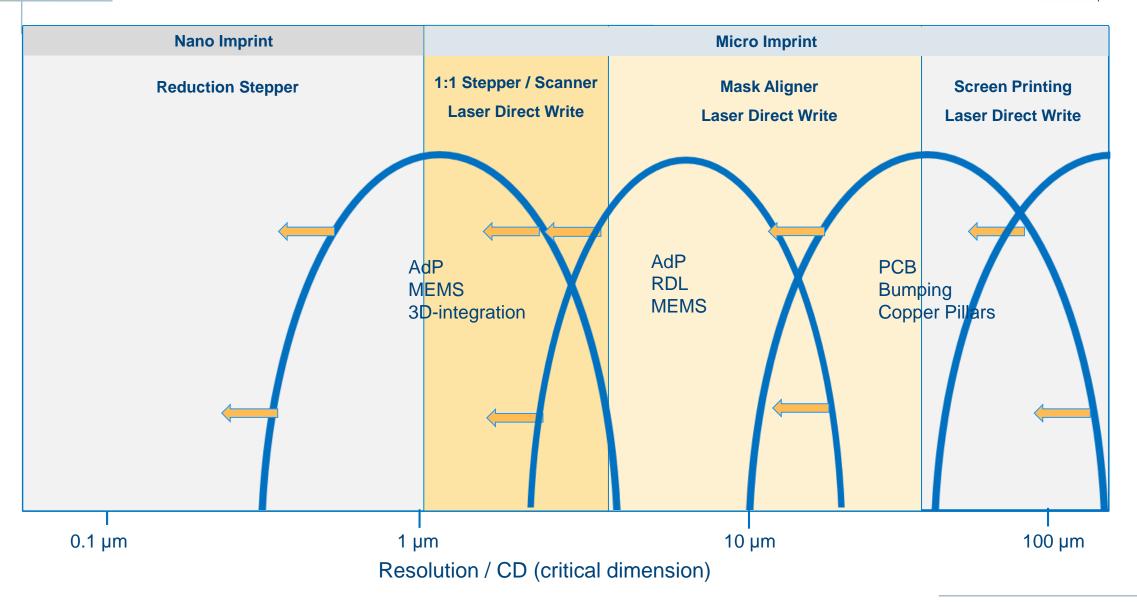
SUSS is offering:

- The widest range of equipment for "More than Moore" applications
- + The best suited equipment for nonstandardized processes
- High degree of customization as processes are different at each customer
- + Equipment optimized for safest operation in 24/7 environments
- + SUSS is known for reliability, efficiency and best-in-class performance



EXPOSURE – BEST FIT FOR DIFFERENT APPLICATIONS

SÜSS_MicroTec









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SUSS 2025 STRATEGY





STRATEGIC TARGETS

+ Top-line growth

- Attractive products for maximum productivity and best in class yield
- Additional features to increase reliability

+ Improved operational performance and profitability

- Operational efficiency to be improved, programs are running
- Cost reduction through out-sourcing and global purchasing
- Increase cash flow by better inventory management

Focus on strategic growth areas

- Strong product offering already short term growth possible
- Platform design programs longer term potential for margin increase

Goal 2025: € 400 million with > 15% EBIT

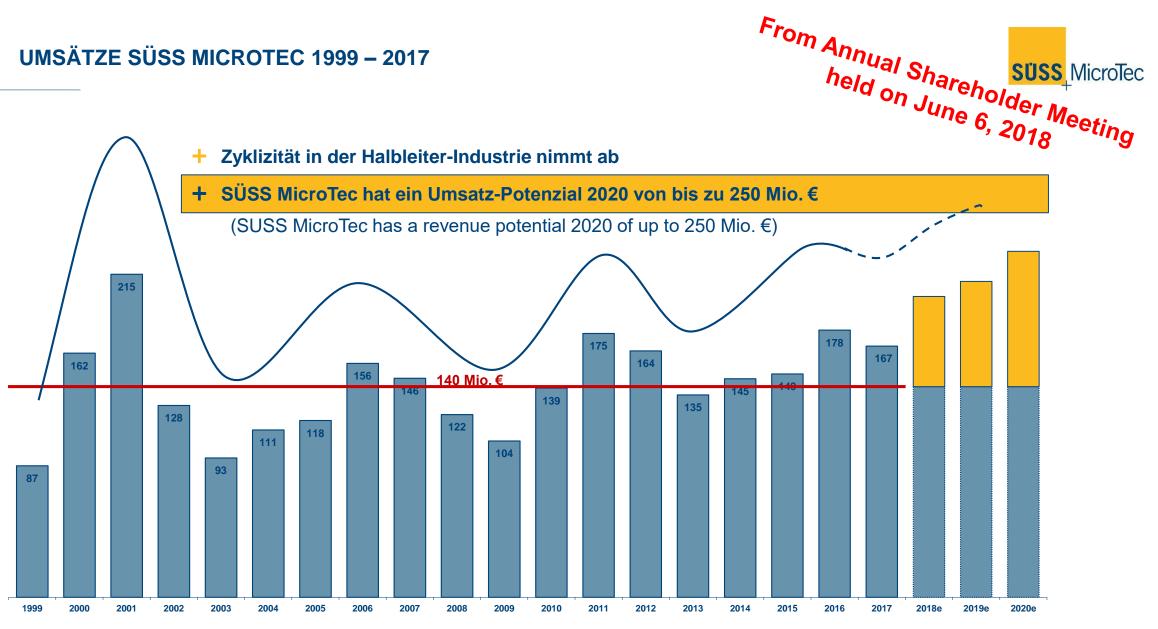
STRATEGY SUSS 2025

SUSS_MicroTec

+ Where we started in 2018 when the strategy was defined

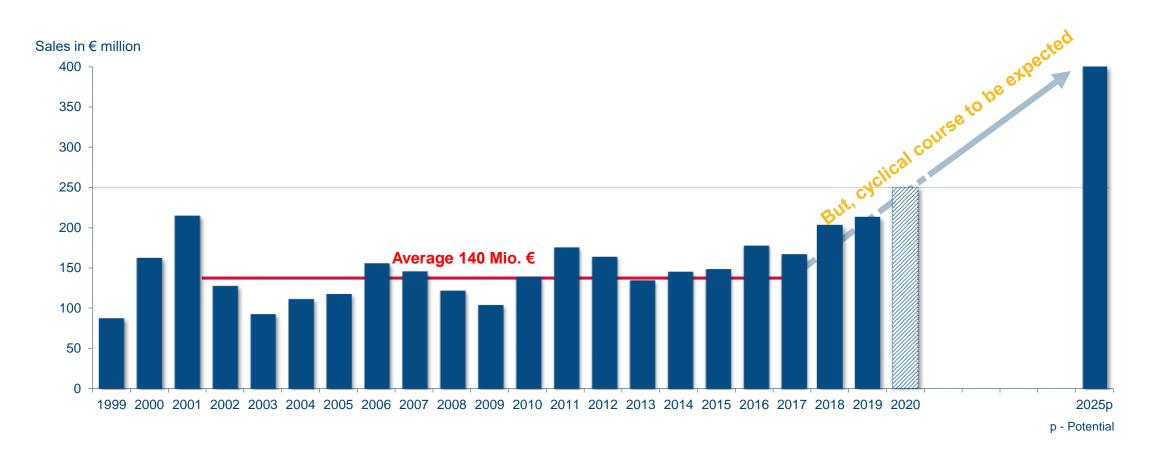
- Suss had not show any significant growth for more than 15 years
- Only a few Business Units had developed meaningful USP's
- But, there was significant momentum in the market
- + Identified growth areas and USP's
 - Advanced Packaging / More-than-Moore applications show significant growth potential
 - SUSS is positioned in Lithography and Bonding
 - Imprint is becoming well accepted technology for structuring in µm and upper-nm scale
- + But: certain shortcomings were discovered on SUSS side
 - Permanent Production Bonder were discontinued some years ago
 - Imprint was not seen as a production method (no automated equipment available)
 - No remarkable USP's for Mask Aligner and Spin Coater available

UMSÄTZE SÜSS MICROTEC 1999 – 2017



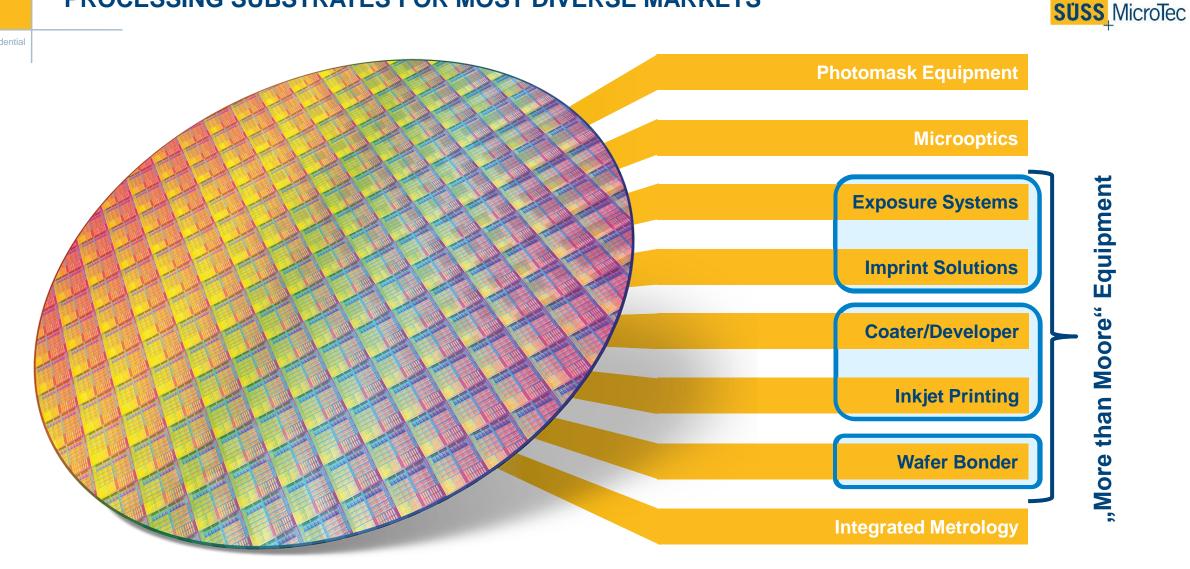
Durchschnittliches Umsatzniveau 1999 – 2017: ca. 140 Mio. €

SUSS 2025 STRATEGY: INCREASE IN SALES



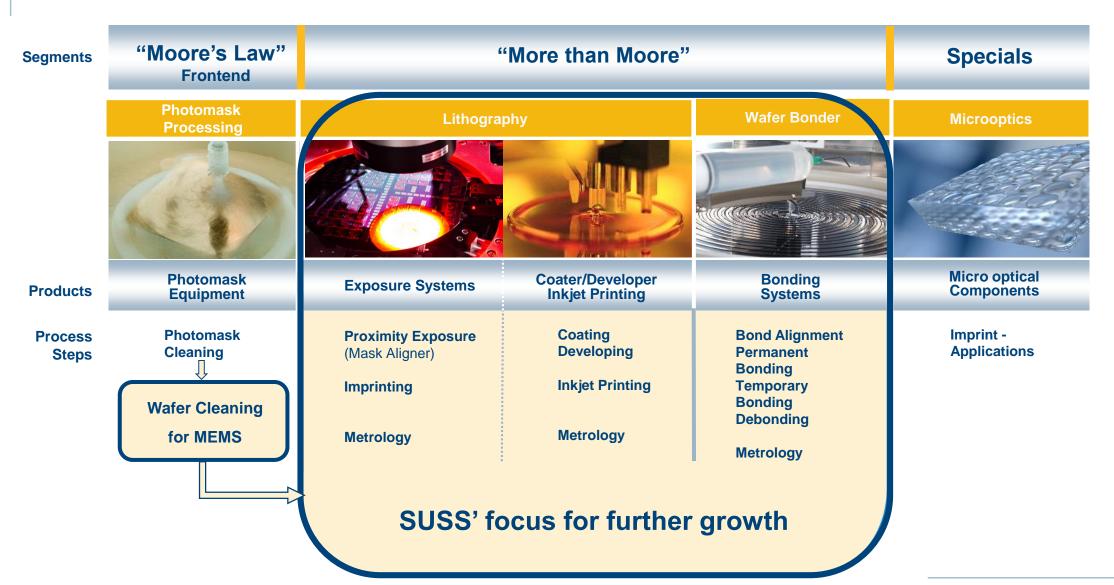
Growth in the coming years through market growth, new products and market share gains

PROCESSING SUBSTRATES FOR MOST DIVERSE MARKETS



SUSS offers the widest range of equipment for "More than Moore" applications \rightarrow strong market position

EQUIPMENT FOR DIFFERENT SEGMENTS AND MARKETS



STRATEGY SUSS 2025 - FOCUS OF ACTIVITY

Operational Improvements: Erik Appel

- Margin Analysis 2017 2019
- Improvements initiated

+ Coater /Developer: Dr. Thomas Grund

- Jet-Coating based on Ink Jet Printing
- High performance, lowest CoO 300mm Tool

+ Exposure Tool: Dr. Markus Arendt

- Automated Imprinting
- Direct Write

+ Bonder: Stefan Lutter

- Automated Permanent Bonder (200mm & 300mm)
- Hybrid Bonding (<100 nm post bond overlay)

+ PhotoMask Equipment: Yuta Nagai

- Insitu-UV for Wafer application, automated tools
- AI-SW-Packages for Smart-Cleaning

+ SMO: Dr. Reinhard Völkel

Expand business to automotive applications

+ Operational performance improving

New products and innovative solutions are coming to market







- **SUSS Positioning in the Market**
- II. Strategy SUSS 2025
- III. Remarks on Q1 and Q2 / 2020

GENERAL BUSINESS UPDATE

- + First half year 2020
 - Strong order entry of €162.6 m (due to package deal)
 - Good contribution by all segments

+ Q2

- Sales of €71.6 m
- Positive EBIT with €8.8 m
- EBIT margin 12.3 %
- Strong business development in Photomask Equipment and Lithography

+ Industry status

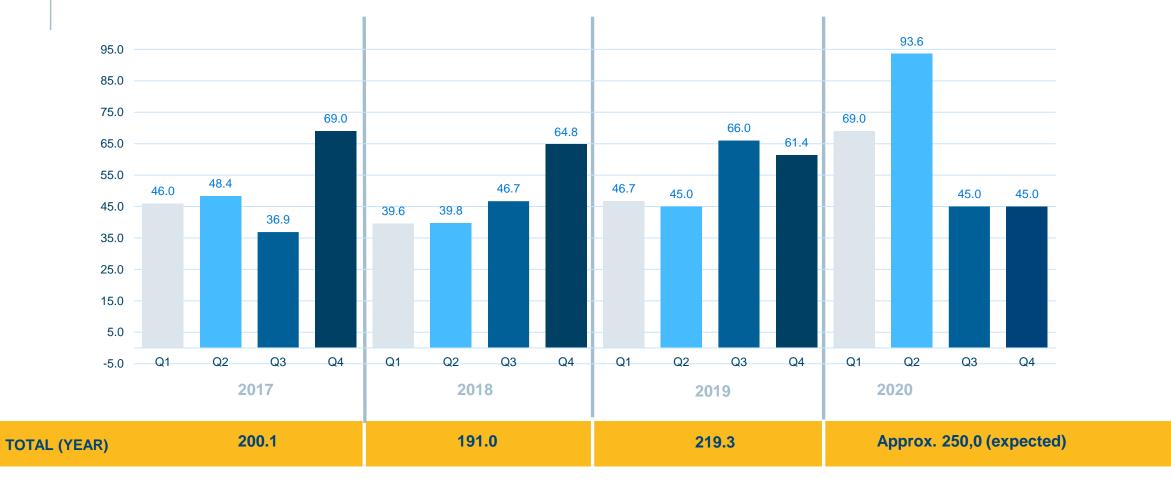
- increased activity in broad band communication segment (5G)
- Focus on delivery and installations
- + COVID-19 pandemic, Impact on current business
 - Low impact on shipments by customer postponements
 - Low impact on shipments from supply chain
 - Uncertainty remains high





ORDER ENTRY: STRONG QUARTERLY PERFORMANCE

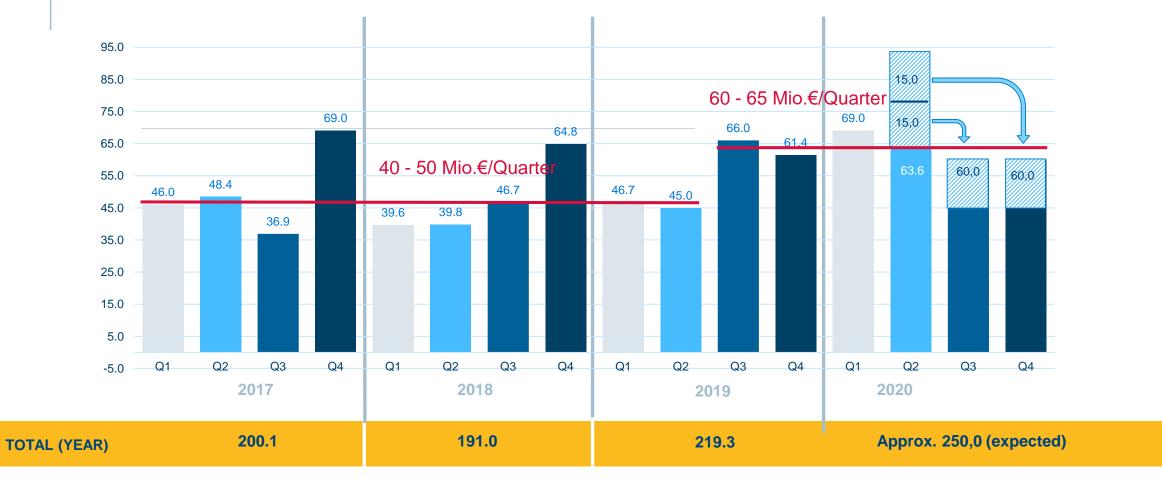




- Strong Order entry in Q2 especially in Lithography, Photomask and Bonder business unit and in Asia Pacific region
- Some major customers have placed big ticket orders for several tools ("Package Deal")
- Increased order backlog of 143 m€

ORDER ENTRY: RUN RATE 60 – 65 MIO. €, AFTER SMOOTHEN OUT A BIT





- Q2 2020 Order entry impacted by bundled order
- Average order intake from Q3 2019 to Q4 2020 is approx. 60 65 Mio. €/Quarter
- Annual run rate is 240 260 Mio. €/a

KEY GROUP FIGURES Q1 / Q2 2020



In € million	Q1 2020	Q1 2019	
Order entry	69.0	46.7	
Order backlog	120.8	85.4	
Sales	41.7	47.1	
EBIT	-5.6	2.1	
EBIT margin	-13.4%	4.5%	
Earnings after tax	-3.8	3.5	
EPS in €	-9.1%	7.4%	
Free cash flow	-5.6	2.1	
Net cash	-0.28	0.02	
Employees 30/6	-8.3	-16.4	

Q2 2020	Q2 2019
93.6	45.0
71.6	47.0
8.8	-2.9
12.3%	-6.2%
5.8	-2.3
0.30	0.12
25,5	-2.5

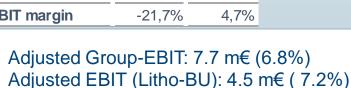
+ 6m-EBIT 3.2m € (2.8%)

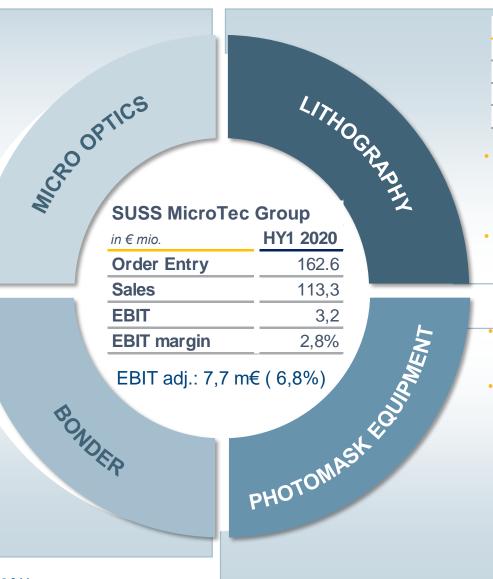
SEGMENT OVERVIEW HY1 2020

in € mio.	HY1 2020	HY1 2019
Order entry	11,6	10,9
Sales	11,3	10,1
EBIT	0,1	1,7
EBIT margin	0,9%	16,8%

- EBIT weaker than previous half year due to short time work and quality problems with key supplier
- Strong growth in order entry but sales and EBIT below expectations due to postponement of shipments of tools with a decent margin

 Improvement in Q3/4 expected 			
in € mio.	HY1 2020	HY1 2019	
Order entry	23,6	13,5	
Sales	9,2	12,9	
EBIT	-2,0	0,6	
EBIT margin	-21,7%	4,7%	





in € mio.	HY1 2020	HY1 2019
Order entry	95,0	41,9
Sales	62,1	51,8
EBIT	0,0	-3,8
EBIT margin	0,0%	-7,3%

- Strong growth in order entry and sales due to big ticket orders and sales with major customers
- 4.5m€ closing cost for US-site in Corona booked in HY1
- Strong order entry and sales development esp. in Q2
- Strong margin increase due high margin sales with a top tier customer

in € mio.	HY1 2020	HY1 2019
Order entry	32,3	25,4
Sales	30,6	19,0
EBIT	9,4	3,3
EBIT margin	30,7%	19,0%

CASH FLOW

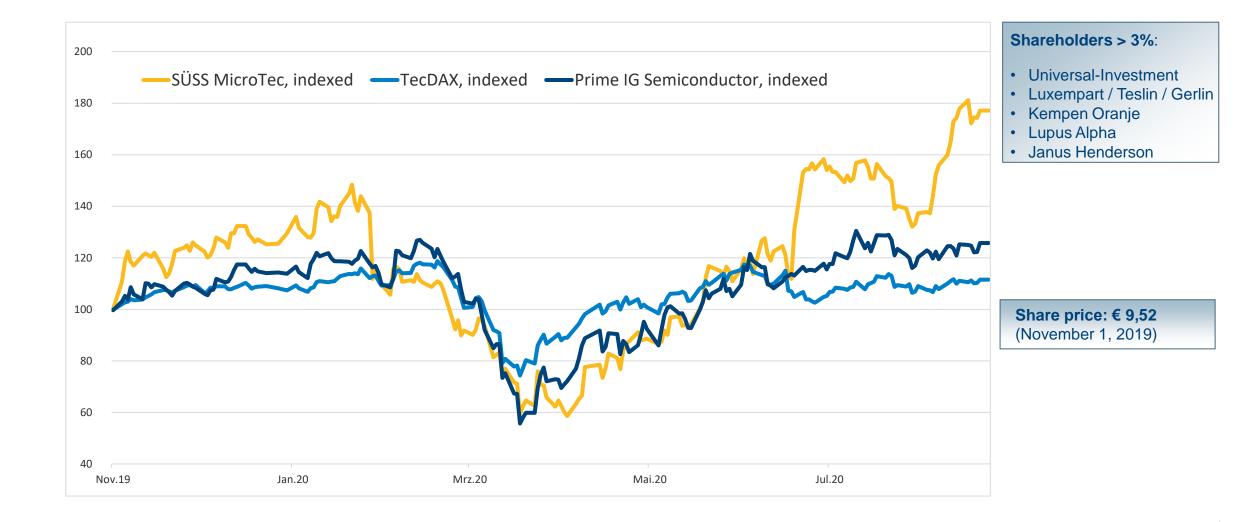


in € thousand	01.01.2020 - 30.06.2020	01.01.2019 - 30.06.2019	in € thousand	01.01.2020 - 30.06.2020	01.01.2019 - 30.06.2019
Net profit / loss (after taxes)	358	-1,878	Disbursements for other tangible assets	-2,522	-3,431
Amortization of intangible assets	302	557	Disbursements for intangible assets	-291	-348
Depreciation of tangible assets	3,279	2,258	Purchases of current available-for-sale securities	-3,280	0
Profit or loss on disposal of intangible and tangible assets	0	61	Cash flow from investing activities	-6,093	-3,779
Change of reserves on inventories	1,325	3,087	Repayment of bank loans	-9,523	-500
Change of reserves for bad debts	-188	58	Increase of bank loans	0	5,000
Non-cash income from the reversal of pension accruals	0	0	Repayment of leasing liabilities	-1,413	-406
Other non-cash effective income and expenses	100	41	Change in other financial debt	0	0
Change in inventories	-1,729	-8,851	Cash flow from financing activities	-10,936	4,094
Change in contract assets	-3,304	-7,801	Adjustments to funds caused by exchange-rate fluctuations	2	7
Change in trade receivables	7,826	9,133	Change in cash and cash equivalents	6,225	-14,772
Change in other assets	-1,533	-132	Funds at beginning of the year	10,280	30,672
Change in pension provisions	297	30	Funds at end of the period	16,505	15,900
Change in trade payables	412	-1,644			
Change in contract liabilities	10,638	-2,312	 Operating Cashflow improved significantly from - 	15 1m € to 23 3 m€	due to
Change in other liabilities and other provisions	-269	-4,838		10.111 C to 20.0 mc.	
Change of tax assets and tax liabilities	5,738	-2,863	 reduced accounts receivables (-€ 7.8m€) 		
Cash flow from operating activities	23,252	-15,094	 tax reimbursements (5,7m€) 		

• Change in accounts payable and contract liabilities (+0,4m€ +10,6m€.)

+ Free Cashflow: increased significantly from -18.9 m€ to +17,2 Mio. €

SÜSS MICROTEC: SHARE PRICE DEVELOPMENT





Thank you a

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